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Vishay Siliconix

P-Channel 60 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	-60					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -10 \text{ V}$	0.120					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$	0.150					
Q _g typ. (nC)	8					
I _D (A) ^a	-4.7					
Configuration	Single					

FEATURES

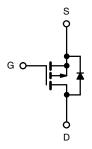
- TrenchFET® power MOSFET
- 100 % UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

• Primary side switch



P-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free	Si9407BDY-T1-E3			
Lead (Pb)-free and halogen-free	Si9407BDY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS	$(T_A = 25 ^{\circ}C, \text{ unless})$	otherwise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-60	V
Gate-source voltage		V _{GS}	± 20	V
-	T _C = 25 °C		-4.7	
O	T _C = 70 °C		-3.8	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-3.2 b, c	
	T _A = 70 °C		-2.6 b, c	
Pulsed drain current (10 µs width)	I _{DM}	-20	Α	
October 1997 and 1997 all all and 1997 and 1997 and 1997 all all and 1997 and 1997 all all and 1997 and 1997 all all and 1997 all all all and 1997 all all all all all all all all all al	T _C = 25 °C		-4.2	
Continuous source-drain diode current	T _A = 25 °C	I _S	-2 b, c	
Avalanche current	1 04	I _{AS}	-15	
Single-pulse avalanche energy	L = 0.1 mH	E _{AS}	11	mJ
	T _C = 25 °C		5	
Maximum power dissipation	T _C = 70 °C	_	3.2	\A/
	T _A = 25 °C	P _D	2.4 b, c	W
	T _A = 70 °C		1.5 b, c	
Operating junction and storage temperature rai	T _J , T _{stq}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, d		R_{thJA}	42	53	°C/W
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	19	25	C/VV

Notes

- a. Based on T_C = 25 $^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 85 °C/W

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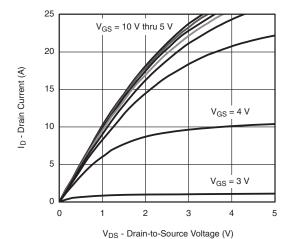
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-50	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	4	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-	-3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1		
		V _{DS} = -60 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10	μA	
On-state drain current a	I _{D(on)}	$V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$	-20	-	-	Α	
D		$V_{GS} = -10 \text{ V}, I_D = -3.2 \text{ A}$	-	0.100	0.120	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -2.9 \text{ A}$	-	0.126	0.150		
Forward transconductance a	g _{fs}	V _{DS} = -15 V, I _D = -3.2 A	-	8.5	-	S	
Dynamic ^b		-		<u> </u>	L		
Input capacitance	C _{iss}		-	600	-	pF	
Output capacitance	C _{oss}	V _{DS} = -30 V, V _{GS} = 0 V, f = 1 MHz	-	70	-		
Reverse transfer capacitance	C _{rss}		-	50	-		
	Q _g	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -3.2 \text{ A}$	-	14.5	22	1	
Total gate charge			-	8	12		
Gate-source charge	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.9 \text{ A}$	-	2.2	-	nC	
Gate-drain charge	Q_{qd}		-	3.7	-		
Gate resistance	R _a	f = 1 MHz	-	14	-	Ω	
Turn-on delay time	t _{d(on)}		-	30	45		
Rise time	t _r	$V_{DD} = -30 \text{ V}, R_{L} = 11.5 \Omega$	-	70	105	ns	
Turn-off delay time	t _{d(off)}	$I_D \cong -2.6 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	40	60		
Fall time	t _f		-	30	45		
Turn-on delay time	t _{d(on)}		-	10	15		
Rise time	t _r	$V_{DD} = -30 \text{ V}, R_1 = 11.5 \Omega$	-	13	20		
Turn-off delay time	t _{d(off)}	$I_D \cong -2.6 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	35	55	ns	
Fall time	t _f		-	30	45		
Drain-Source Body Diode Characteris	tics	<u> </u>					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-4.2		
Pulse diode forward current	I _{SM}		-	-	-20	Α	
Body diode voltage	V_{SD}	I _S = -2 A, V _{GS} = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	30	50	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -2 A, di/dt = -100 A/μs,	-	35	60	nC	
Reverse recovery fall time	ta	T _J = 25 °C	-	16	-		
Reverse recovery rise time	t _b		_	14	_	ns	

Notes

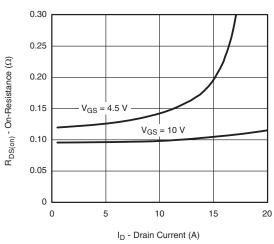
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

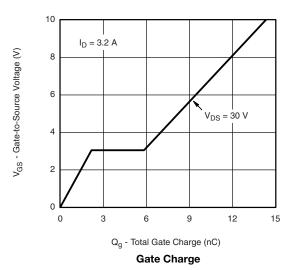


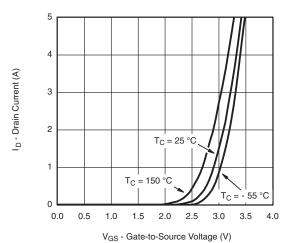


Output Characteristics

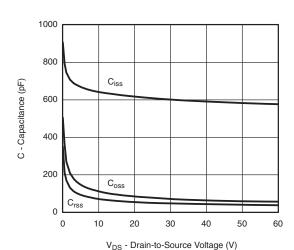


On-Resistance vs. Drain Current

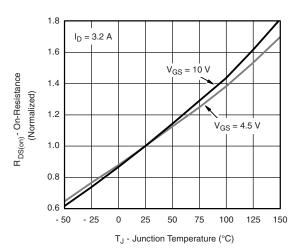




Transfer Characteristics

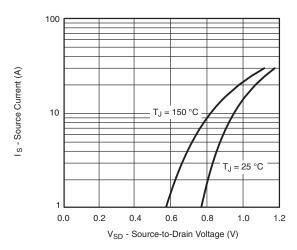


Capacitance

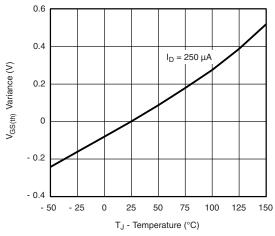


On-Resistance vs. Junction Temperature

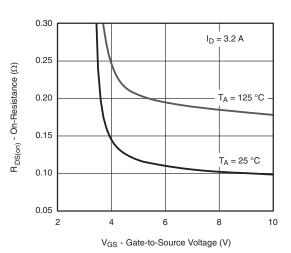




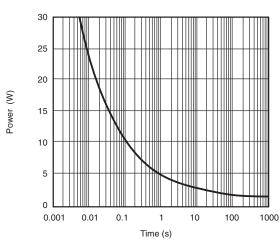
Source-Drain Diode Forward Voltage



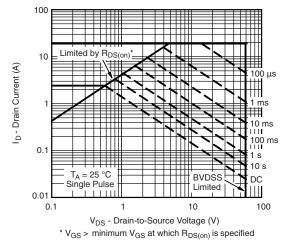
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

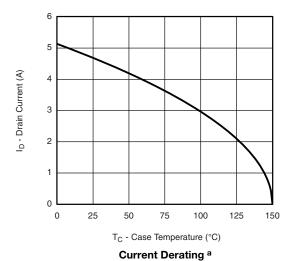


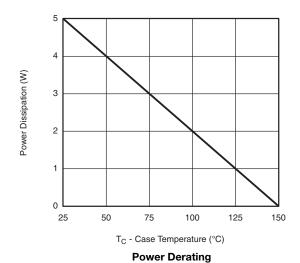
Single Pulse Power, Junction-to-Ambient



Safe Operating Area



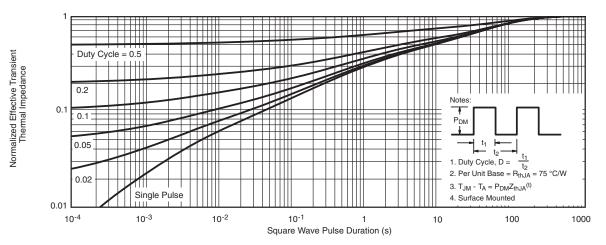




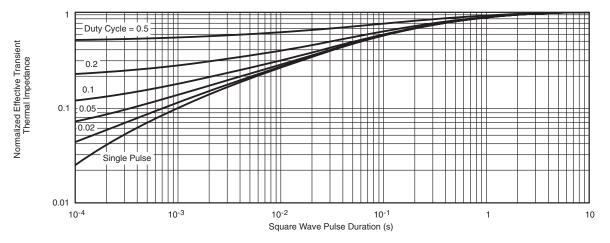
Note

a. The power dissipation P_D is based on T_J max = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

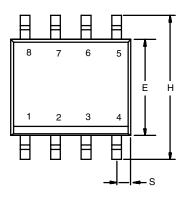


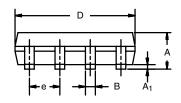
Normalized Thermal Transient Impedance, Junction-to-Foot

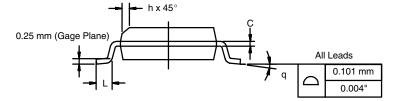
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

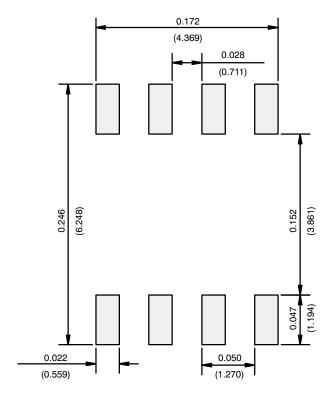
DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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